IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Kie Y. Ahn et al.

Title:

LANTHANIDE OXIDE L'HAFNIUM OXIDE DIELECTRIC LAYERS

Docket No.:

1303.101US1

Filed:

June 24, 2003

Examiner:

Unknown

APR 1 2 2004

Serial No.: 10/602323

Due Date: N/A

Group Art Unit: 2812

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

X A return postcard.

X A Communication Concerning Related Applications (4 pgs.).

X An Information Disclosure Statement (2 pgs.), Form 1449 (2 pgs.), and copies of 28 cited documents.

If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

Customer Number 21186

Atty: David R. Cochran

Mosker

Reg. No. 46,632

<u>CERTIFICATE UNDER 37 CFR 1.8:</u> The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this day of April, 2004.

Name

Signature

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

(GENERAL)



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Applicant: Kie Y. Ahn et al.

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LANTHANIDE OXIDE / HAFNIUM OXIDE DIELECTRIC LAYERS

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

In compliance with the duty imposed by 37 C.F.R. § 1.56, and in accordance with 37 C.F.R. §§ 1.97 *et. seq.*, the enclosed materials are brought to the attention of the Examiner for consideration in connection with the above-identified patent application. Applicants respectfully request that this Information Disclosure Statement be entered and the documents listed on the attached Form 1449 be considered by the Examiner and made of record. Pursuant to the provisions of MPEP 609, Applicants request that a copy of the 1449 form, initialed as being considered by the Examiner, be returned to the Applicants with the next official communication.

Pursuant to 37 C.F.R. §1.97(b), it is believed that no fee or statement is required with the Information Disclosure Statement. However, if an Office Action on the merits has been mailed, the Commissioner is hereby authorized to charge the required fees to Deposit Account No. 19-0743 in order to have this Information Disclosure Statement considered.

Serial No :10/602323

Filing Date: June 24, 2003

Title: LANTHANIDE OXIDE / HAFNIUM OXIDE DIELECTRIC LAYERS

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The Examiner is invited to contact the Applicants' Representative at the below-listed telephone number if there are any questions regarding this communication.

Respectfully submitted,

KIE Y. AHN ET AL.

By their Representatives,

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Date 8 /18/11 2004

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<u>S/N 10/602323</u> <u>PATENT</u>

IN THE UNITED STATES PREENT AND TRADEMARK OFFICE

APR 1 2 2004

Applicant:

Kie Y. Ahn et al.

Serial No.:

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Filed:

June 24, 2003

Title:

LANTHANIDE OXIDE HAF YUM OXIDE DIELECTRIC LAYERS

Examiner: Unknown

Group Art Unit: 2812

Docket: 1303.101US1

COMMUNICATION CONCERNING RELATED APPLICATION(S)

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Applicants would like to bring to the Examiner's attention the following related application(s) in the above-identified patent application:

Serial/Patent No. 09/944981	Filing Date August 30, 2001	Attorney Docket 1303.021US1	Title CRYSTALLINE OR AMOPHOUS MEDIUM-K GATE OXIDES, Y203 AND Gd203
09/945535	August 30, 2001	1303.026US1	HIGHLY RELIABLE AMORPHOUS HIGH-K GATE OXIDE ZrO2
10/028643	December 20, 2001	1303.030US1	LOW-TEMPERATURE GROWN HIGH QUALITY ULTRA-THIN CoTiO3 GATE DIELECTRICS
10/052983	January 17, 2002	1303.031US1	HIGHLY RELIABLE AMORPHOUS HIGH-k GATE DIELECTRIC ZrOxNy
10/027315	December 20, 2001	1303.033US1	LOW-TEMPERATURE GROWN HIGH- QUALITY ULTRA-THIN PRASEODYMIUM GATE DIELECTRICS
09/797324	March 1, 2001	303.717US1	METHODS, SYSTEMS, AND APPARATUS FOR UNIFORM CHEMICAL-VAPOR DEPOSITIONS
10/099194	March 13, 2002	1303.044US1	EVAPORATION OF Y-Si-O FILMS FOR MEDIUM-k DIELETRICS
10/081439	February 20, 2002	1303.046US1	EVAPORATED LaAIO3 FILMS FOR GATE DIELECTRICS

COMMUNICATION CONCERNING RELATED APPLICATIONS

Serial Number: 10/602323
Filing Date: June 24, 2003
Title: LANTHANIDE OXIDE / HAFNIUM OXIDE DIELECTRIC LAYERS

Page 2 Dkt: 1303.101US1

10/137058	May 2,	303.802US1	ATOMIC LAYER DEPOSITION AND
10/13/038	2002	303.002031	CONVERSION
10/137168	May 2, 2002	1303.048US1	METHODS FOR ATOMIC-LAYER DEPOSITION OF ALUMINUM OXIDES
	2002		IN INTEGRATED CIRCUITS
10/137499	May 2, 2002	1303.050US1	ATOMIC LAYER-DEPOSITED LaAIO3 FILMS FOR GATE DIELETRICS
10/163481	June 5, 2002	1303.056US1	ATOMIC LAYER-DEPOSITED HFAIO3 FILMS FOR GATE DIELECTRICS
10/163686	June 5, 2002	1303.059US1	Pr2O3-BASED La-oxide GATE DIELECTRICS
10/209581	July 30, 2002	1303.061US1	ATOMIC LAYER DEPOSITED NANOLAMINATES OF HfO2/ZrO2
			FILMS AS GATE DIELECTRICS
10/219870	August 15, 2002	1303.069US1	LANTHANIDE DOPED TIOX DIELECTRIC FILMS BY PLASMA OXIDATION
10/219878	August 15, 2002	1303.070US1	LANTHANIDE DOPED TiOx DIELECTRIC FILMS
10/229903	August 28, 2002	1303.078US1	ATOMIC LAYER DEPOSITED HISION DIELECTRIC FILMS
10/233309	August 29, 2002	1303.079US1	ATOMIC LAYER DEPOSITED LANTHANIDE DOPED TIOX
			DIELECTRIC FILMS
10/309583	December 4, 2002	1303.082US1	ATOMIC LAYER DEPOSITED ZR-SN- TI-O FILMS USING TiI4
10/309935	December 4, 2002	1303.083US1	ATOMIC LAYER DEPOSITED Zr-Sn-Ti-O FILMS
10/379470	March 4, 2003	1303.090US1	ATOMIC LAYER DEPOSITED DIELECTRIC LAYERS

COMMUNICATION CONCERNING RELATED APPLICATIONS Serial Number: 10/602323 Filing Date: June 24, 2003 Title: LANTHANIDE OXIDE / HAFNIUM OXIDE DIELECTRIC LAYERS

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10/403734	March 31, 2003	1303.092US1	ATOMIC LAYER DEPOSITED ZrAlxOy DIELECTRIC LAYERS
10/420307	April 22, 2003	1303.097US1	ATOMIC LAYER DEPOSITED ZrTiO4 FILMS
10/602315	June 24, 2003	1303.107US1	LANTHANIDE OXIDE / HAFNIUM OXIDE DIELECTRICS
09/779959 6,495,436	February 9, 2001	Unknown	FORMATION OF METAL OXIDE GATE DIELECTRIC
09/838335 6514828	April 20, 2001	Unknown	METHOD OF FABRICATING A HIGHLY RELIABLE GATE OXIDE
09/881408	June 13, 2001	Unknown	DIELECTRIC LAYER FORMING METHOD AND DEVICES FORMED THEREWITH
09/908767 6534420	July 18, 2001	Unknown	METHODS FOR FORMING DIELECTRIC MATERIALS AND METHODS FOR FORMING SEMICONDUCTOR DEVICES
10/765619	January 27, 2004	1303.033US2	LOW-TEMPERATURE GROWN HIGH- QUALITY ULTRA-THIN PRASEODYMIUM GATE DIELECTRICS
10/768597	January 30, 2004	1303.033US3	LOW-TEMPERATURE GROWN HIGH- QUALITY ULTRA-THIN PRASEODYMIUM GATE DIELECTRICS
10/789042	February 27, 2004	1303.050US2	ATOMIC LAYER-DEPOSITED LaAlO3 FILMS FOR GATE DIELETRICS
10/789044	February 27, 2004	1303.070US2	LANTHANIDE DOPED TIOX DIELECTRIC FILMS

COMMUNICATION CONCERNING RELATED APPLICATIONS

Serial Number: 10/602323 Filing Date: June 24, 2003

Title: LANTHANIDE OXIDE / HAFNIUM OXIDE DIELECTRIC LAYERS

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Unknown	October 10, 2003	Unknown	LANTHANIDE OXIDE/ ZIRCONIUM OXIDE ATOMIC LAYER DEPOSITED NANOLAMINATE GATE DIELECTRICS
10/052983	January 17, 2002	Unknown	HIGHLY RELIABLE AMORPHOUS HIGH K GATE DIELECTRIC ZROXNY
10/225715	August 21, 2002	Unknown	COMPOSITE DIELECTRIC FORMING METHODS AND COMPOSITE DIELECTRICS
10/352507	January 27, 2003	Unknown .	ATOMIC LAYER DEPOSITION OF METAL OXYNITRIDE LAYERS AS GATE DIELECTRICS AND SEMICONDUCTOR DEVICE STRUCTURES UTILIZING METAL OXYNITRIDE LAYERS

Respectfully submitted,

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By Applicants' Representatives,

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Date & April 2004 B

David R. Cochran

Reg. No. 46,632

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Name

Signature

PTO/SB/08A(10-01)
Approved for use through 10/31/2002. OMB 651-0031
US Patent & Trademark Office. U.S. DEPARTMENT OF COMMERCE
ter the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of Information unfess it contains a valid OMB control number. Substitute for form 1449A/PTO Complete if Known INFORMATION DISCLOSUBE STATEMENT BY APPLOANTS **Application Number** 10/602323 June 24, 2003 (Use as many sheets as necessary **Filing Date** Ahn, Kie **First Named Inventor** APR 1 2 2004 2812 **Group Art Unit** Unknown **Examiner Name** Attorney Docket No: 1303.101US1 Sheet 1 of 2

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		AARIK, JAAN, et al., "Influence of substrate temperature on atomic layer growth and properties of HfO/sub 2/ thin films", Thin Solid Films, 340(1-2), (1999),110-116	

EXAMINER

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Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control number. Substitute for form 1449A/PTO Complete if Known INFORMATION DISCLOSURE **Application Number** 10/602323 STATEMENT BY APPLICANT
(Use as many sheets as necessary) June 24, 2003 Filing Date Ahn, Kie **First Named Inventor** APR 1 2 2004 **Group Art Unit** 2812 Unknown **Examiner Name** Attorney Docket No: 1303.101US1 Sheet 2 of 2

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DATE CONSIDERED EXAMINER